

# FH3050GS6

## N-Channel Enhancement Mode Power MOSFET

### Description

The FH3050GS6 uses advanced Shielded Gate trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

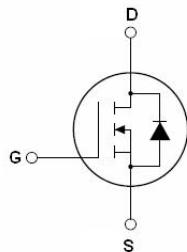
### General Features

$V_{DSS}$	$I_D$	$R_{DS(ON)} \text{ ( MAX )}$	
		$V_{GS}=10V$	$V_{GS}=4.5V$
30V	50A	6.5mΩ	9.5mΩ

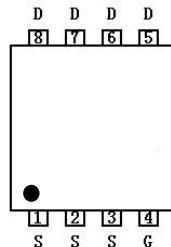
### Application

- Motor drivers
- DC - DC Converter

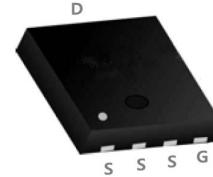
- Surface-mounted package
- Low Thermal Resistance



Schematic dia gram



Markinga nd pin Assignment



PDFN3.3x3.3-8L top and bottom view

### Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	Drain-Source Voltage	$T_C = 25^\circ\text{C}$	30	-	V
$V_{GS}$	Gate-Source Voltage	$T_C = 25^\circ\text{C}$	-	$\pm 20$	V
$I_D^{***}$	Drain Current	$T_C = 25^\circ\text{C}, V_{GS} = 10\text{ V}$	-	50	A
$I_{DM}^{****,***}$	Pulsed Source Current	$T_C = 25^\circ\text{C}, V_{GS} = 10\text{ V}$	-	112	A
$P_{tot}^*$	Total Power Dissipation	$T_C = 25^\circ\text{C}$	-	20.8	W
$T_{stg}$	Storage Temperature		-55	150	$^\circ\text{C}$
$T_J$	Junction Temperature		-	150	$^\circ\text{C}$
$I_S$	Diode Forward Current	$T_C = 25^\circ\text{C}$	-	50	A
$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient		-	62.5	$^\circ\text{C} / \text{W}$
$R_{\theta JC}^*$	Thermal Resistance- Junction to Case		-	6	$^\circ\text{C} / \text{W}$

Notes :

\* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10$  sec

\*\* Pulse width  $\leq 10\ \mu\text{s}$ , duty cycle  $\leq 1\ %$

\*\*\* limited by bonding wire

Note: NHCX defines " Green " as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## Electrical Characteristics (TC=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{DS} = 250 \mu\text{A}$	1.0	-	2.0	V
$I_{DSS}$	Zero Gate Voltage Source Current	$V_{DS} = 24, V_{GS} = 0 \text{ V}$ $T_J = 85^\circ\text{C}$	-	-	1	$\mu\text{A}$
$I_{GSS}$	Gate Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	$\pm 100$	nA
$R_{DS(\text{ON})}^a$	Drain-Source On-State Resistance	$V_{GS} = 10 \text{ V}, I_D = 20\text{A}$	-	5.8	6.5	$\text{m}\Omega$
		$V_{GS} = 4.5 \text{ V}, I_D = 10\text{A}$	-	8.9	9.5	
<b>Diode Characteristics</b>						
$V_{SD}^a$	Diode Forward Voltage	$I_{SD} = 20 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	1.3	V
$t_{rr}$	Reverse Recovery Time	$I_{SD} = 20 \text{ A}, dI_{SD}/dt = 100 \text{ A}/\mu\text{s}$	-	23	-	nS
$Q_{rr}$	Reverse Recovery Charge		-	10	-	nC
<b>Dynamic Characteristics<sup>b</sup></b>						
$C_{iss}$	Input Capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 15 \text{ V}$ Frequency = 1 MHz	-	731	-	$\text{pF}$
$C_{oss}$	Output Capacitance		-	380	-	
$C_{rss}$	Reverse Transfer Capacitance		-	34	-	
$t_d(\text{on})$	Turn-on Delay Time	$V_{DS} = 15 \text{ V}, V_{GEN} = 10 \text{ V},$ $R_G = 4.5 \Omega, R_L = 0.75\Omega,$ $I_D = 20 \text{ A}$	-	6.8	-	$\text{nS}$
$t_r$	Turn-on Rise Time		-	55	-	
$t_d(\text{off})$	Turn-off Delay Time		-	12	-	
$t_f$	Turn-off Fall Time		-	20	-	
<b>Gate Charge Characteristics<sup>b</sup></b>						
$Q_g$	Total Gate Charge	$V_{GS} = 10 \text{ V}, V_{DS} = 15 \text{ V},$ $I_{DS} = 20 \text{ A}$	-	14	-	$\text{nC}$
$Q_{gs}$	Gate-Source Charge		-	3.2	-	
$Q_{gd}$	Gate-Drain Charge		-	2.2	-	

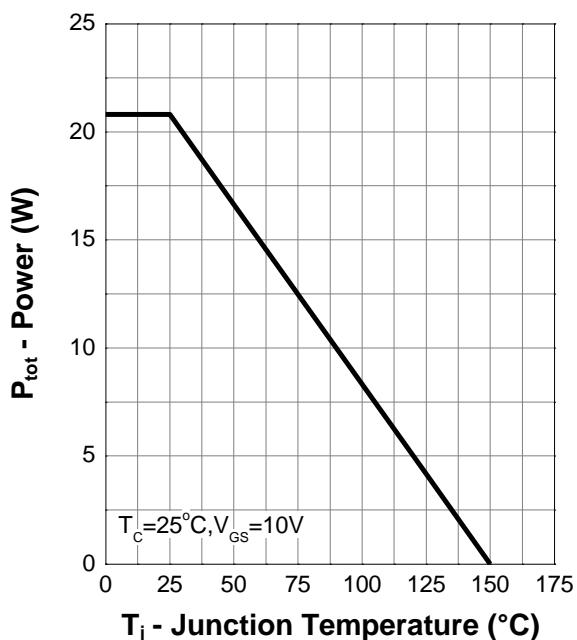
Notes :

a : Pulse test ; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ 

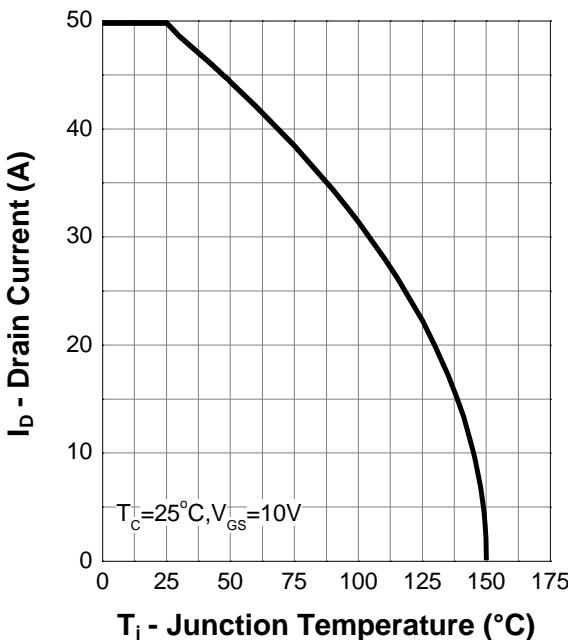
b : Guaranteed by design, not subject to production testing

## Typical Characteristics (Cont.)

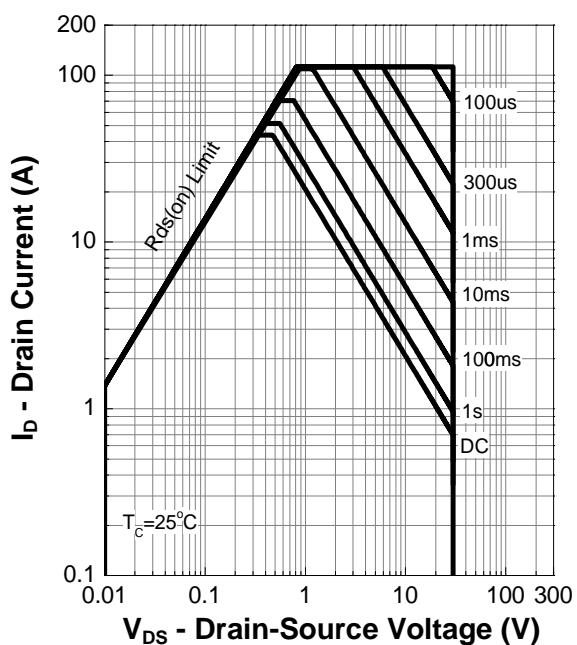
Power Capability



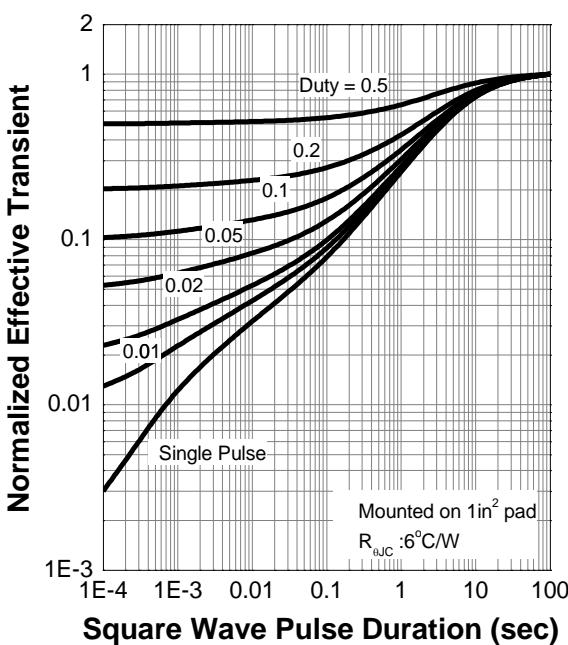
Current Capability



Safe Operating Area

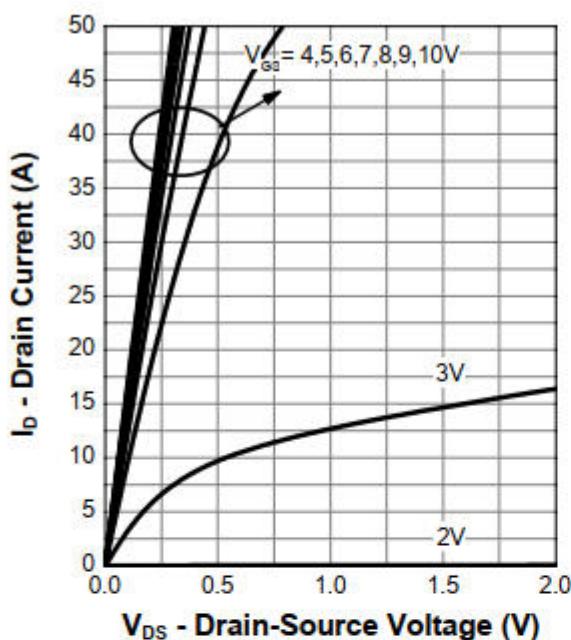


Transient Thermal Impedance

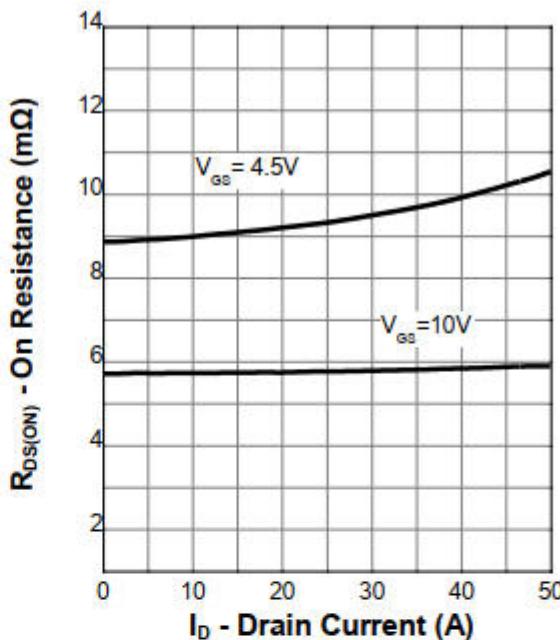


## Typical Characteristics (Cont.)

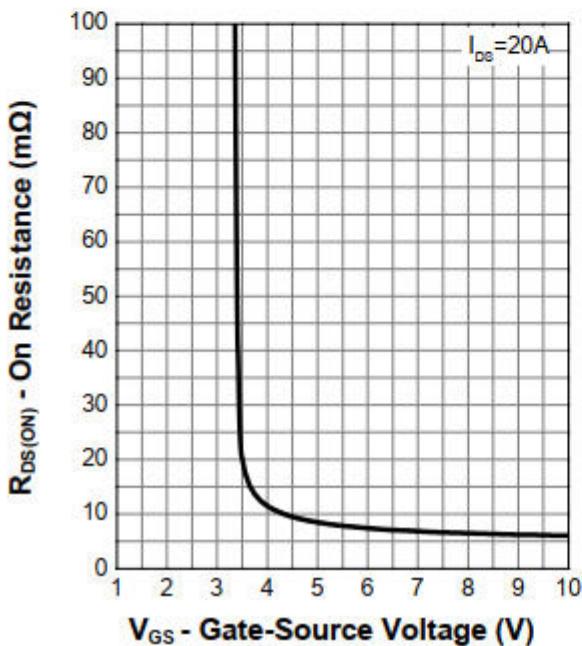
Output Characteristics



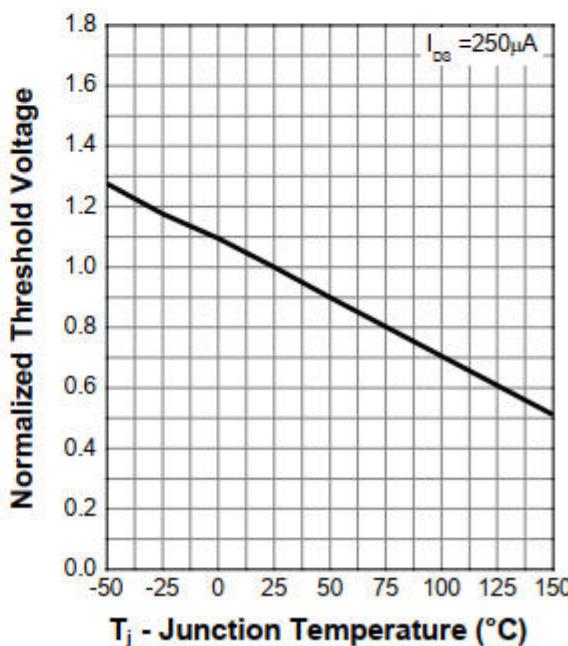
On Resistance



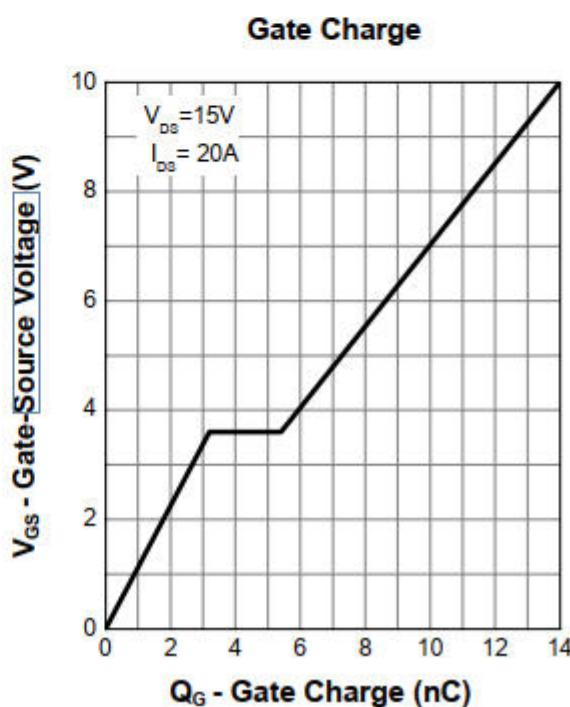
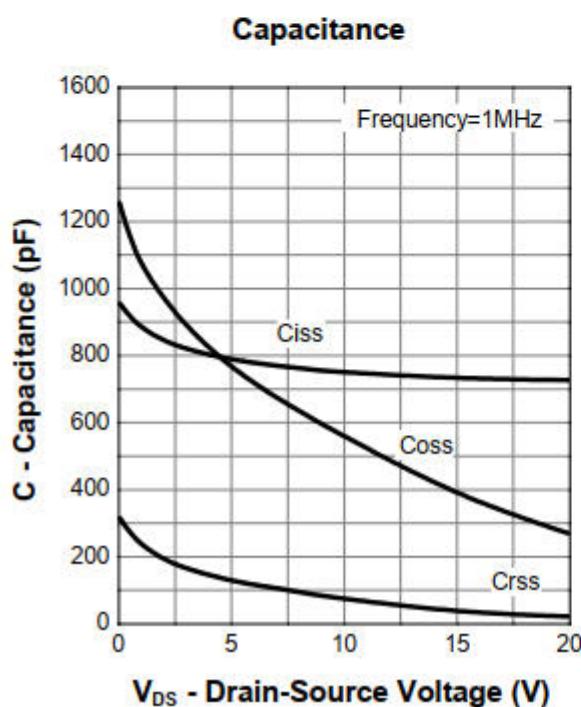
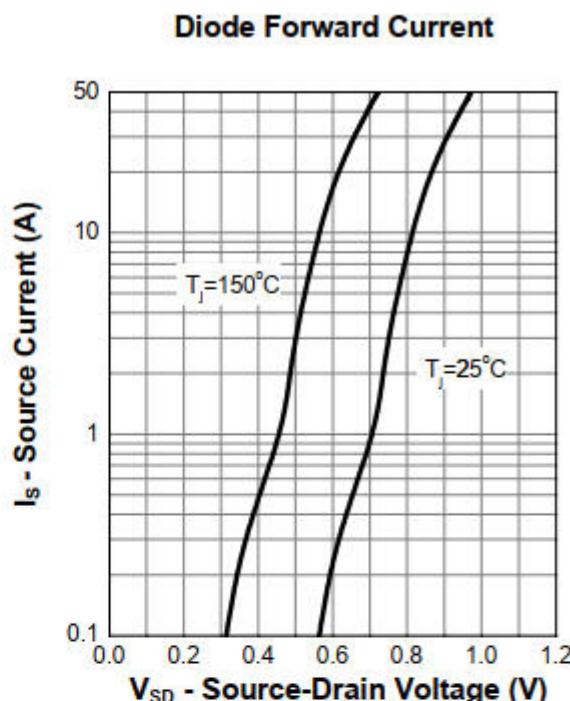
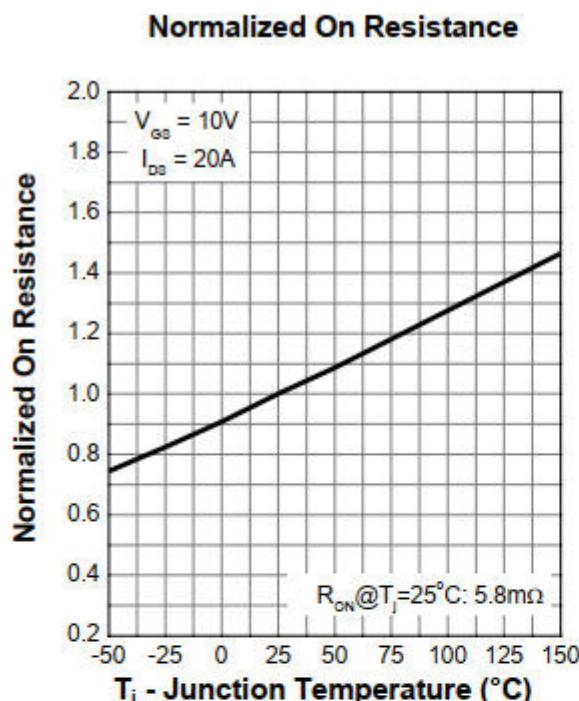
Transfer Characteristics



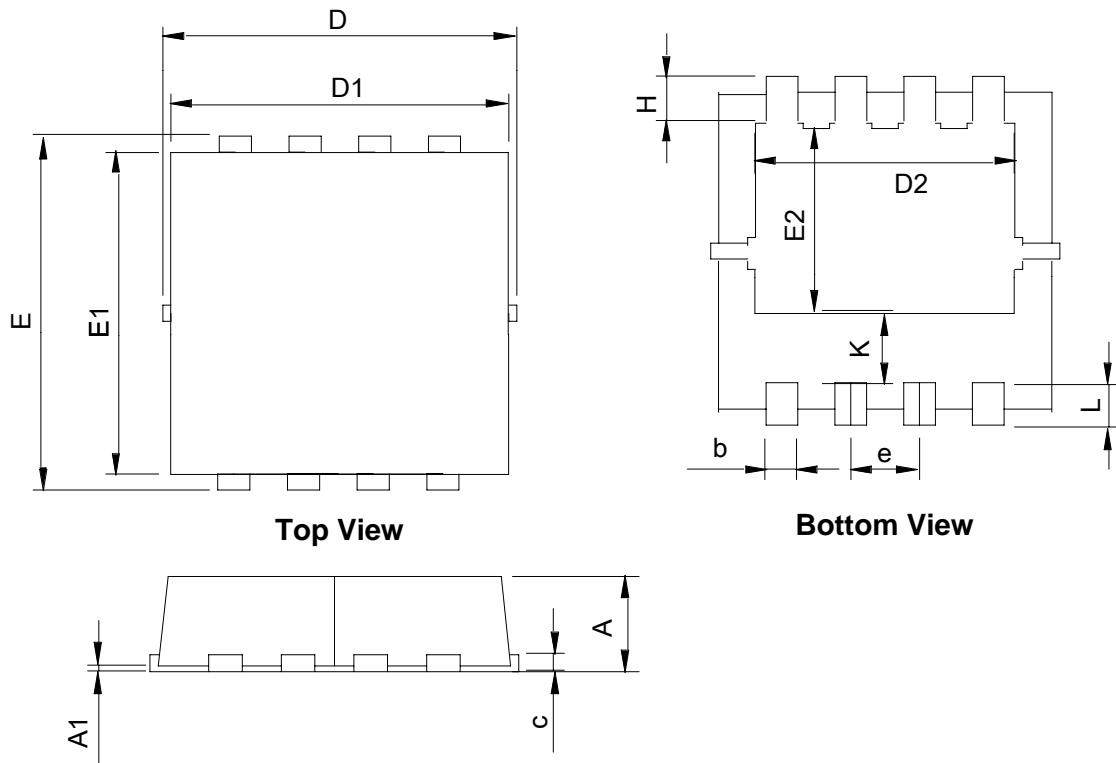
Normalized Threshold Voltage



## Typical Characteristics (Cont.)



## Package Information : PDFN3.3x3.3-8L



SYMBOL	PDFN3.3x3.3-8L			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	0.70	1.00	0.028	0.039
A1	0.00	0.05	0.000	0.002
b	0.25	0.35	0.010	0.014
c	0.14	0.20	0.006	0.008
D	3.10	3.50	0.122	0.138
D1	3.05	3.25	0.120	0.128
D2	2.35	2.55	0.093	0.100
E	3.10	3.50	0.122	0.138
E1	2.90	3.10	0.114	0.122
E2	1.64	1.84	0.065	0.072
e	0.65 BSC		0.026 BSC	
H	0.32	0.52	0.013	0.020
K	0.59	0.79	0.023	0.031
L	0.25	0.55	0.010	0.022